

PowerDI5060-8

100V N-CHANNEL ENHANCEMENT MODE MOSFET

<1.1mm Package Profile – Ideal for Thin Applications (PowerDI®)

Case Material: Molded Plastic, "Green" Molding Compound.

Terminals: Finish - Matte Tin Annealed over Copper Leadframe.

Thermally Efficient Package - Cooler Running Applications



Product Summary

BV _{DSS}	R _{DS(ON)} Max	Ι _D T _C = +25°C
100V	16m @ V _{GS} = 10V	44A
100 V	18m @ V _{GS} = 6.0V	41A

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize $R_{DS(ON)}$, yet maintain superior switching performance. This device is ideal for use in notebook battery power management and loadswitch.

Applications

Motor Control DC-DC Converters Power Management

PowerDI5060-8



Motor Control

Features

High Conversion Efficiency

Low Input Capacitance Fast Switching Speed

Mechanical Data

Case: PowerDI5060-8

Low R_{DS(ON)} - Minimizes On-State Losses

UL Flammability Classification Rating 94V-0 Moisture Sensitivity: Level 1 per J-STD-020 Terminal Connections Indicator: See Diagram

Solderable per MIL-STD-202, Method 208

Weight: 0.097 grams (Approximate)

Lead-Free Finish; RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3) Qualified to AEC-Q101 Standards for High Reliability

> SC D D G

Internal Schematic

Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
DMT10H015LPS-13	PowerDI5060-8	2,500/Tape & Reel

EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



) :: = Manufacturer's Marking T1015LS = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)

O VY WW YY = Last Two Digits of Year (ex: 17 WW = Week Code (01 to 53)

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	100	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Noto 5) // 40//	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	7.3 5.8	А
Continuous Drain Current (Note 5) $V_{GS} = 10V$	Steady State	T _C = +25°C T _C = +100°C	ID	44 28	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	150	A		
Maximum Continuous Body Diode Forward Current (Not	ls	1.5	A		
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			I _{SM}	150	А
Avalanche Current (Note 7) L = 3mH			I _{AS}	7.5	А
Avalanche Energy (Note 7) L = 3mH			E _{AS}	85	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.3	W
Thermal Resistance, Junction to Ambient (Note 5)		R ja	98	°C/W
Total Power Dissipation	$T_{C} = +25^{\circ}C$	PD	46	W
Thermal Resistance, Junction to Case		R _{JC}	2.7	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

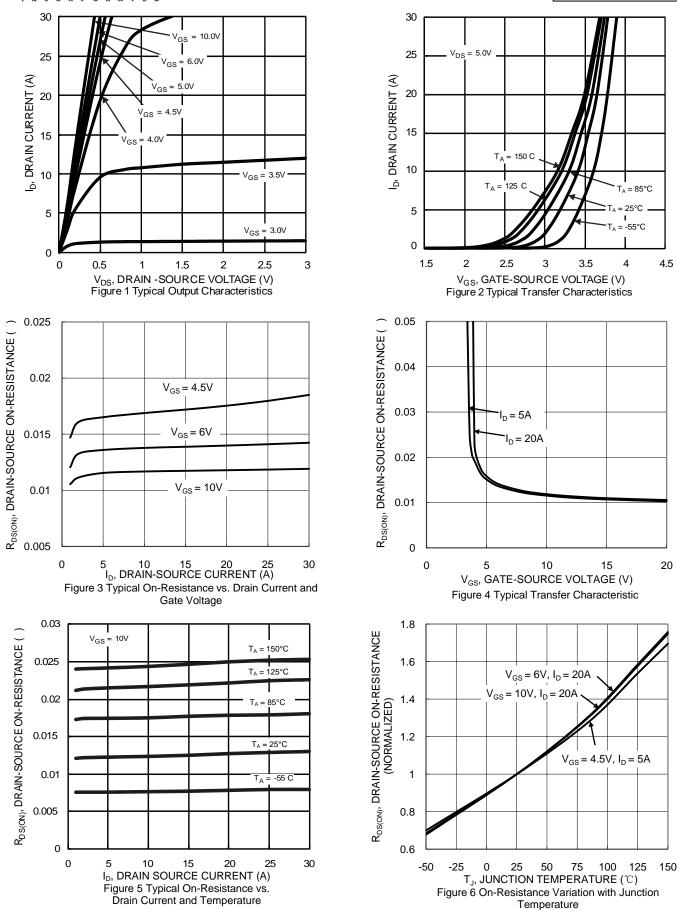
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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	-	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	—	_	1	μA	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	—	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(TH)}	1.4	2.3	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
		_	11	16		$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	13.5	18	m	$V_{GS} = 6V, I_D = 20A$	
		_	18	25		$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	V _{SD}	_	0.9	1.3	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss	_	1871	—		$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss	_	261	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	6.9	—			
Gate Resistance	R _G	_	0.75	_		$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q _G	_	33.3	_		V 50V L 40A	
Gate-Source Charge	Q _{GS}		6.9	_	nC	$V_{DD} = 50V, I_D = 10A, V_{GS} = 10V$	
Gate-Drain Charge	Q _{GD}	_	5.1	_			
Turn-On Delay Time	t _{D(ON)}		6.5	—			
Turn-On Rise Time	t _R	_	7.0	_		$V_{DD} = 50V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}		19.7	—	ns	$I_D = 10A, R_G = 6$	
Turn-Off Fall Time	t _F	_	8.1	—	1		
Reverse Recovery Time	t _{RR}	_	37.9	_	ns		
Reverse Recovery Charge	Q _{RR}	_	51.9	_	nC	$I_F = 10A$, di/dt = 100A/µs	

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

6. Short duration pulse test used to minimize self-heating effect.
 7. Guaranteed by design. Not subject to product testing.

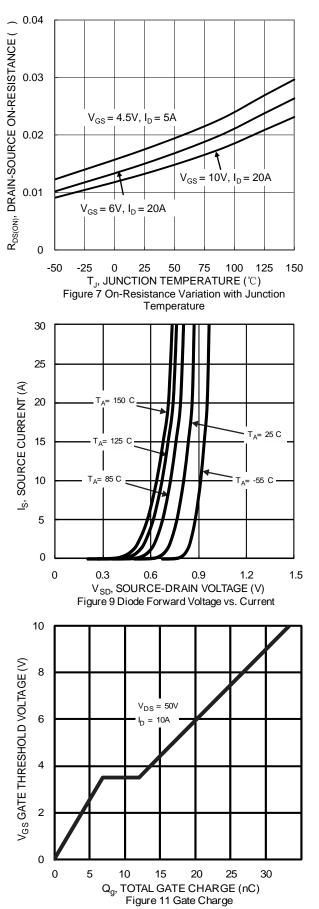


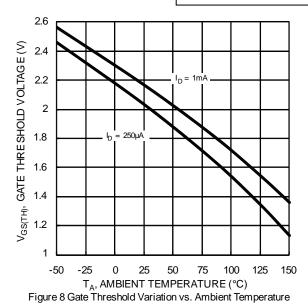


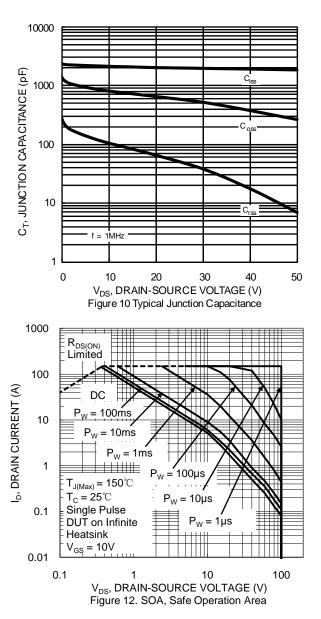




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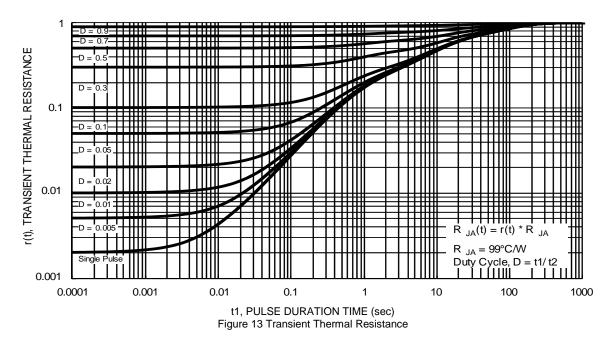






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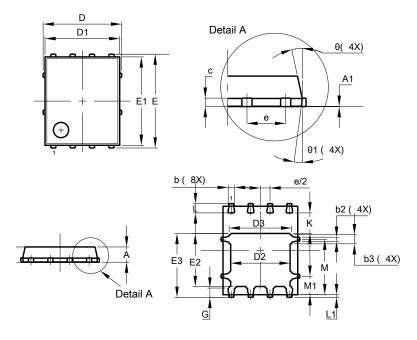




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

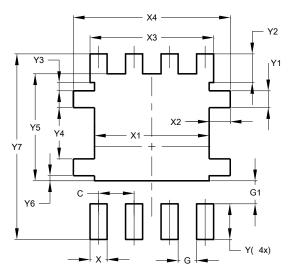


	PowerDI5060-8					
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0.00	0.05				
b	0.33	0.51	0.41			
b2	0.200	0.350	0.273			
b3	0.40	0.80	0.60			
c	0.230	0.330	0.277			
D		5.15 BSC				
D1	4.70	5.10	4.90			
D2	3.70	4.10	3.90			
D3	3.90	4.30	4.10			
E		6.15 BSC	;			
E1	5.60	6.00	5.80			
E2	3.28	3.68	3.48			
E3	3.99	4.39	4.19			
е		1.27 BSC				
G	0.51	0.71	0.61			
K	0.51					
L	0.51	0.71	0.61			
L1	0.100	0.200	0.175			
М	3.235	4.035	3.635			
M1	1.00	1.40	1.21			
Θ	10°	12°	11°			
Θ1	6°	8°	7°			
AI	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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